



# SYSTEM AND A METHOD FOR PLATING OF A CONDUCTIVE PATTERN

Van Steenkiste et al.

Appl. No.: 09/744,465 Atty Docket: IMEC228.001APC

#7  
attach

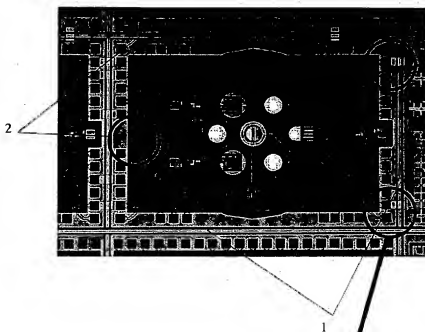


Figure 1

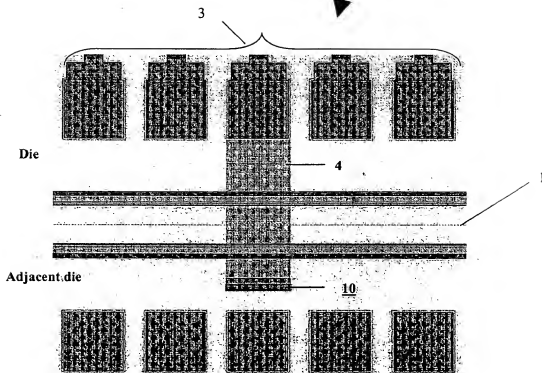


Figure 2



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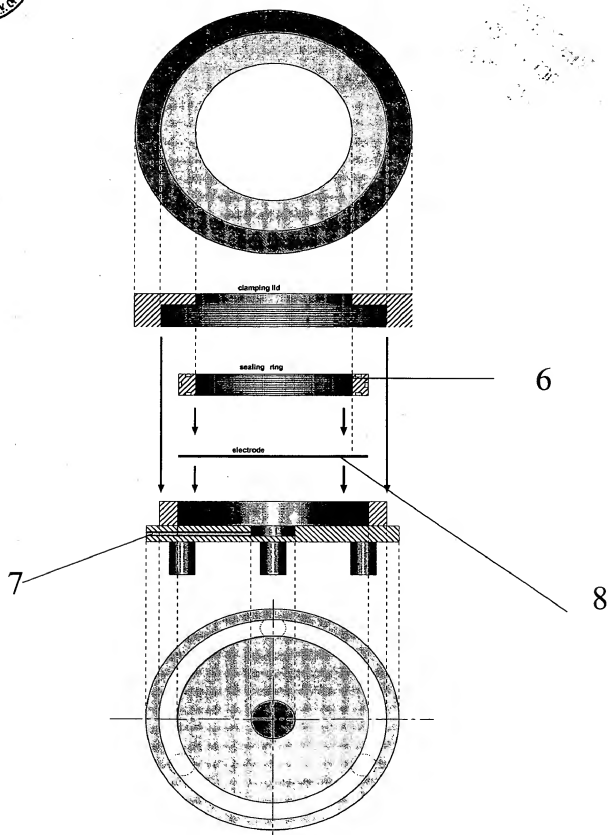


Figure 3



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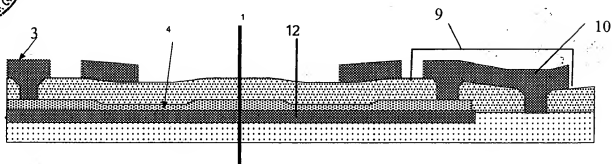


Figure 4